

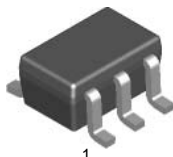
# 2N7002DW

## N-Channel Enhancement Mode Field Effect Transistor

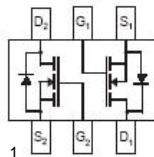
### Features

- Dual N-Channel MOSFET
- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Ultra-Small Surface Mount Package
- Lead Free/RoHS Compliant

SC70-6 (SOT363)



Marking : 2N



### Absolute Maximum Ratings \* $T_a = 25^\circ\text{C}$ unless otherwise noted

| Symbol         | Parameter                                   | Value                            | Units            |
|----------------|---|----------------------------------|------------------|
| $V_{DSS}$      | Drain-Source Voltage                        | 60                               | V                |
| $V_{DGR}$      | Drain-Gate Voltage $R_{GS} \leq 1.0M\Omega$ | 60                               | V                |
| $V_{GSS}$      | Gate-Source Voltage                         | Continuous                       | $\pm 20$         |
|                |   | Pulsed                           | $\pm 40$         |
| $I_D$          | Drain Current                               | Continuous                       | 115              |
|                |   | Continuous @ $100^\circ\text{C}$ | 73               |
|                |   | Pulsed                           | 800              |
| $T_J, T_{STG}$ | Junction and Storage Temperature Range      | -55 to +150                      | $^\circ\text{C}$ |

\* These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

### Thermal Characteristics

| Symbol          | Parameter   | Value | Units                      |
|-----------------|---|-------|----------------------------|
| $P_D$           | Total Device Dissipation<br>Derating above $T_A = 25^\circ\text{C}$ | 200   | mW                         |
|                 |   | 1.6   | $\text{mW}/^\circ\text{C}$ |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient *                           | 625   | $^\circ\text{C}/\text{W}$  |

\* Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch, Minimum land pad size,

**Electrical Characteristics**  $T_C = 25^\circ\text{C}$  unless otherwise noted

| Symbol | Parameter | Test Condition | MIN | TYP | MAX | Units |
|--------|-----------|----------------|-----|-----|-----|-------|
|--------|-----------|----------------|-----|-----|-----|-------|

**Off Characteristics** (Note1)

|            |                                 |  |    |            |            |         |
|------------|---------------------------------|--|----|------------|------------|---------|
| $BV_{DSS}$ | Drain-Source Breakdown Voltage  | $V_{GS} = 0V, I_D = 10\mu A$   | 60 | 78         | -          | V       |
| $I_{DSS}$  | Zero Gate Voltage Drain Current | $V_{DS} = 60V, V_{GS} = 0V$<br>$V_{DS} = 60V, V_{GS} = 0V, @T_C = 125^\circ\text{C}$ | -  | 0.001<br>7 | 1.0<br>500 | $\mu A$ |
| $I_{GSS}$  | Gate-Body Leakage               | $V_{GS} = \pm 20V, V_{DS} = 0V$  | -  | 0.2        | $\pm 10$   | nA      |

**On Characteristics** (Note1)

|              |                                  |   |        |             |             |          |
|--------------|----------------------------------|---|--------|-------------|-------------|----------|
| $V_{GS(th)}$ | Gate Threshold Voltage           | $V_{DS} = V_{GS}, I_D = 250\mu A$   | 1.0    | 1.76        | 2.0         | V        |
| $R_{DS(ON)}$ | Satic Drain-Source On-Resistance | $V_{GS} = 5V, I_D = 0.05A,$<br>$V_{GS} = 10V, I_D = 0.5A, @T_j = 125^\circ\text{C}$ | -<br>- | 1.6<br>2.53 | 7.5<br>13.5 | $\Omega$ |
| $I_{D(ON)}$  | On-State Drain Current           | $V_{GS} = 10V, V_{DS} = 7.5V$   | 0.5    | 1.43        | -           | A        |
| $g_{FS}$     | Forward Transconductance         | $V_{DS} = 10V, I_D = 0.2A$  | 80     | 356.5       | -           | mS       |

**Dynamic Characteristics**

|           |                              |  |   |      |     |    |
|-----------|------------------------------|--|---|------|-----|----|
| $C_{iss}$ | Input Capacitance            | $V_{DS} = 25V, V_{GS} = 0V, f = 1.0\text{MHz}$ | - | 37.8 | 50  | pF |
| $C_{oss}$ | Output Capacitance           |  | - | 12.4 | 25  | pF |
| $C_{rss}$ | Reverse Transfer Capacitance |  | - | 6.5  | 7.0 | pF |

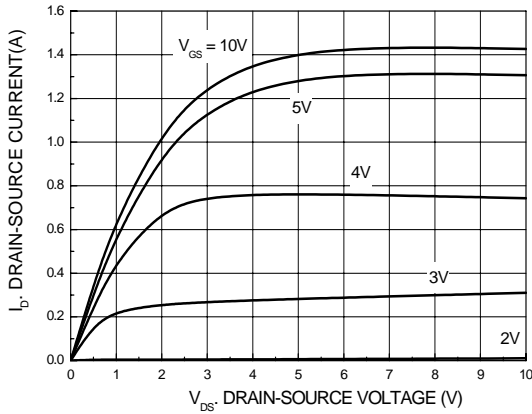
**Switching Characteristics**

|              |                     |  |   |      |    |    |
|--------------|---------------------|--|---|------|----|----|
| $t_{D(ON)}$  | Turn-On Delay Time  | $V_{DD} = 30V, I_D = 0.2A, V_{GEN} = 10V$<br>$R_L = 150\Omega, R_{GEN} = 25\Omega$ | - | 5.85 | 20 | ns |
| $t_{D(OFF)}$ | Turn-Off Delay Time |  | - | 12.5 | 20 |    |

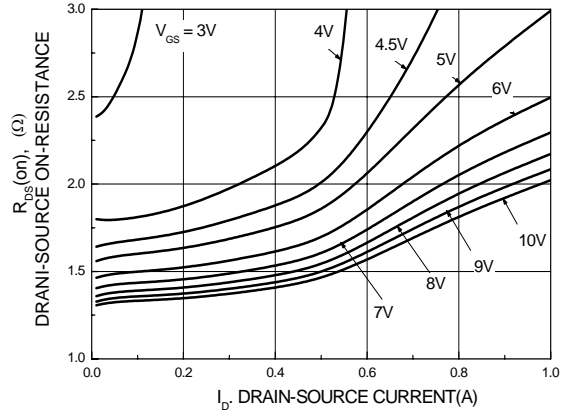
Note1 : Short duration test pulse used to minimize self-heating effect.

## Typical Performance Characteristics

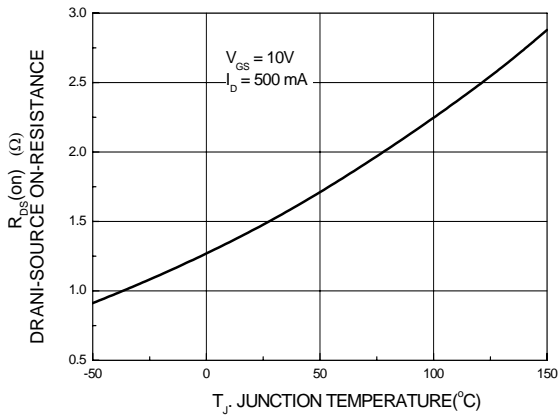
**Figure 1. On-Region Characteristics**



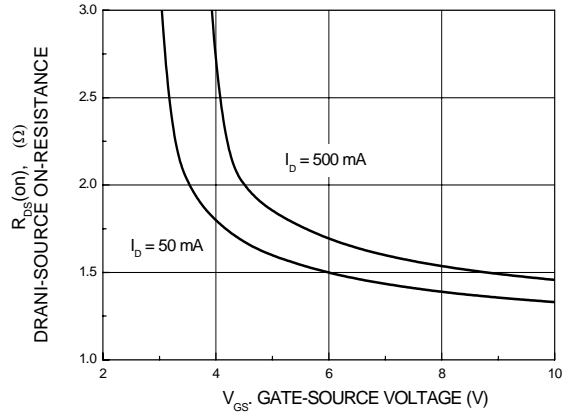
**Figure 2. On-Resistance Variation with Gate Voltage and Drain Current**



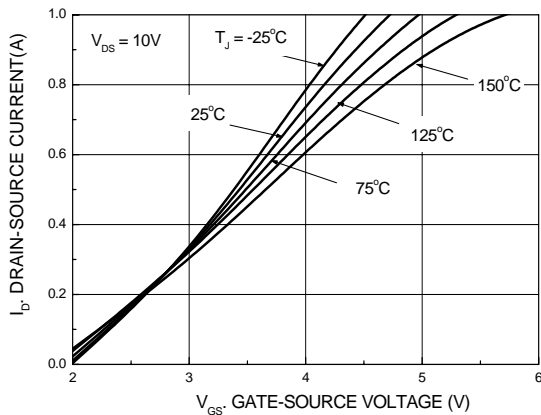
**Figure 3. On-Resistance Variation with Temperature**



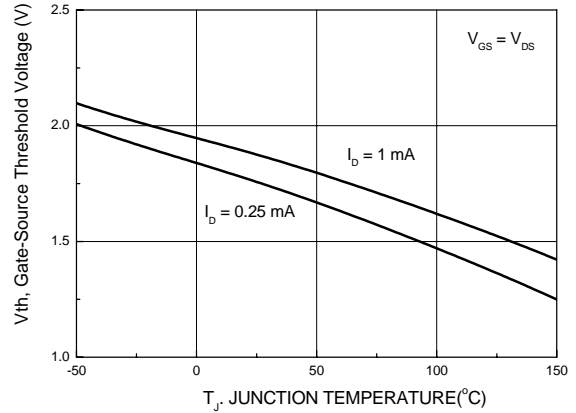
**Figure 4. On-Resistance Variation with Gate-Source Voltage**



**Figure 5. Transfer Characteristics**

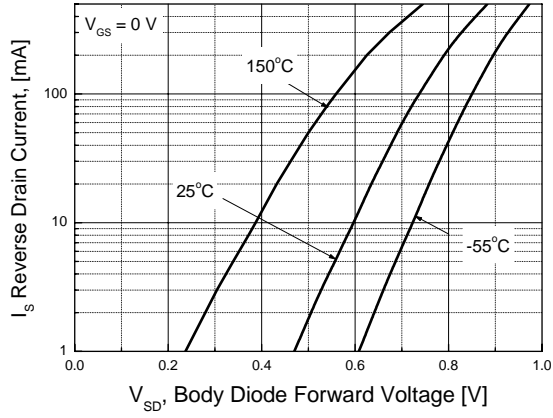


**Figure 6. Gate Threshold Variation with Temperature**

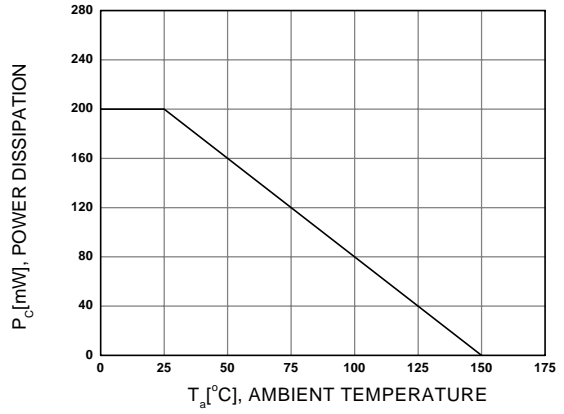


### Typical Performance Characteristics

**Figure 7. Reverse Drain Current Variation with Diode Forward Voltage and Temperature**

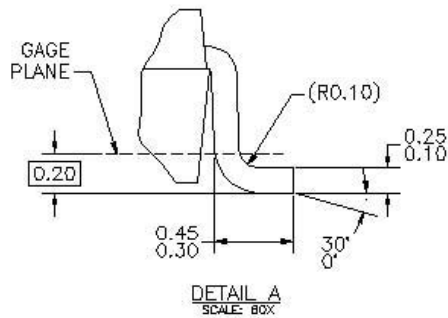
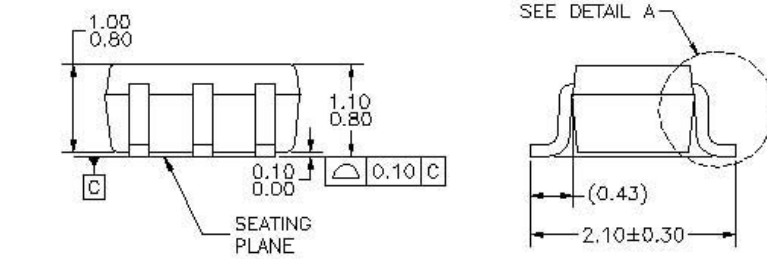
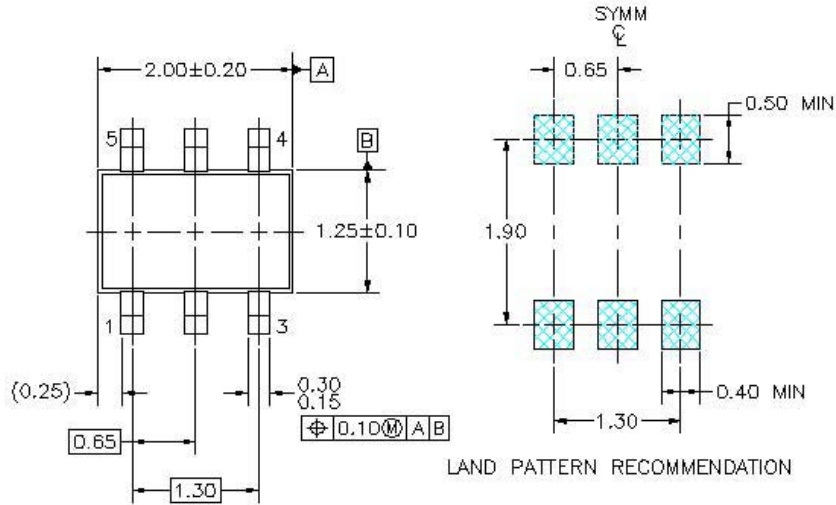


**Figure 8. Power Derating**



# Package Dimensions

## SC70-6 (SOT-363)



NOTES: UNLESS OTHERWISE SPECIFIED

- A) THIS PACKAGE CONFORMS TO EIAJ SC-66, 1996.
- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DIMENSIONS DO NOT INCLUDE BURRS OR MOLD FLASH.



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| FRFET®                   | Power220®   | SuperSOT™-6                |                               |
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